

**AMENDMENTS TO THE CLAIMS:**

1. (Currently Amended) A heat dissipating structure for a computer host, comprising:  
a casing having a front side, a back side, a left side and a right side;  
a mother board having a CPU, plural electrical components mounted thereon;  
a first heat dissipating fin module mounted on the CPU and a second heat dissipating fin module ~~mounted to each abutted to and aligned with the first heat dissipating fin module~~ to form a heat dissipating device ~~mounted on the CPU~~ for dissipating heat generated ~~therefrom the CPU~~,

wherein the left side and the right side respectively have a left side board and a right side board for opening thereon plural ventilative openings corresponding to each other, and the plural ventilative openings on respective left side board and right side board are opened at positions facing the heat dissipating device.

2. (Cancelled)

3. (Currently Amended) The heat dissipating structure for a computer host according to claim 1, wherein two outside surfaces of the first heat dissipating fin module and the second heat dissipating fin module have a first heat dissipating fan and a second heat dissipating fan alignedly mounted ~~[[there]]~~ on two opposite sides of the heat dissipating device facing towards the ventilative openings respectively.

4. (Currently Amended) The heat dissipating structure for a computer host according to claim 3, wherein the first heat dissipating fan and the second heat dissipating fan are rotated at the same direction to draw wind outside the case from the right side to the left side ~~or from the left side to the right side/left side~~ flowing through the heat dissipating device and taking heat from the CPU to flow outside ~~from the left side/right side~~.

Claims 5-7 (Cancelled).

8. (New) The heat dissipating structure for a computer host according to claim 1, wherein the first heat dissipating fin module and the second heat dissipating fin module are parallel to stack each other.